

Variant: 001
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 TID #: TIDA-00796

TIDA-00796 REV E1 Bill of Materials



Item #	Designator	Quantity	Value	PartNumber	Manufacturer	Description	PackageReference
1	!PCB	1		TIDA-00796	Any	Printed Circuit Board	
2	D1, D2	2	Green	150060GS75000	Würth Elektronik	LED, Green, SMD	LED_0603
3	D3, D4	2	Yellow	150060YS75000	Würth Elektronik	LED, Yellow, SMD	LED_0603
4	J4, J5	2		PRPC008DAAN-RC	Sullins Connector Solutions	Header, 2.54mm, 8x2, Gold, TH	Header, 2.54mm, 8x2, TH
5	J57, J86	2		SSW-110-21-S-D	Samtec	Receptacle, 2.54mm, 10x2, Gold, TH	Receptacle, 2.54mm, 10x2, TH
6	R1	1	1.20k	RC0603FR-071K2L	Yageo America	RES, 1.20 k, 1%, 0.1 W, 0603	0603
7	R2	1	330	RC0603FR-07330RL	Yageo America	RES, 330, 1%, 0.1 W, 0603	0603
8	R3	1	10.0k	RC0603FR-0710KL	Yageo America	RES, 10.0 k, 1%, 0.1 W, 0603	0603
9	R4, R5	2	680	RC0603FR-07680RL	Yageo America	RES, 680, 1%, 0.1 W, 0603	0603
10	S1	1		434121025816	Würth Elektronik	Switch, Tactile, SPST, 12 V, SMD	SMD, 6x3.9mm

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